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ON Semiconductor®

## FDWS9420-F085

### N-Channel PowerTrench® MOSFET

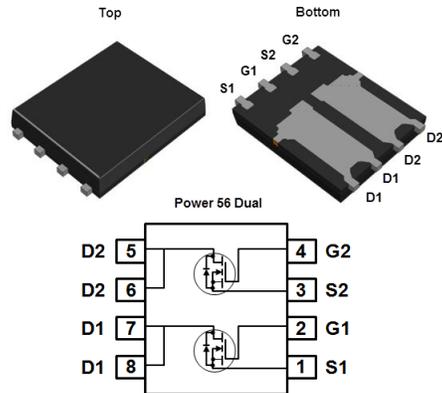
40 V, 20 A, 5.8 mΩ

#### Features

- Typical  $R_{DS(on)}$  = 5.0 mΩ at  $V_{GS} = 10V$ ,  $I_D = 20 A$
- Typical  $Q_{g(tot)}$  = 29 nC at  $V_{GS} = 10V$ ,  $I_D = 20 A$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101
- Wettable flanks for automatic optical inspection (AOI)

#### Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12V Systems



#### MOSFET Maximum Ratings $T_J = 25^\circ C$ unless otherwise noted.

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain-to-Source Voltage	40	V
$V_{GS}$	Gate-to-Source Voltage	±20	V
$I_D$	Drain Current - Continuous ( $V_{GS}=10$ ) (Note 1)	$T_C = 25^\circ C$	20
	Pulsed Drain Current	$T_C = 25^\circ C$	See Figure 4
$E_{AS}$	Single Pulse Avalanche Energy (Note 2)	98	mJ
$P_D$	Power Dissipation	75	W
	Derate Above $25^\circ C$	0.5	W/ $^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature	-55 to + 175	$^\circ C$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2	$^\circ C/W$
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)	50	$^\circ C/W$

#### Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^\circ C$ ,  $L = 1mH$ ,  $I_{AS} = 14A$ ,  $V_{DD} = 40V$  during inductor charging and  $V_{DD} = 0V$  during time in avalanche.
- 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDWS9420	FDWS9420-F085	Power56	13"	12mm	3000units

**Electrical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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**Off Characteristics**

$B_{V_{DS}}$	Drain-to-Source Breakdown Voltage	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$	40	-	-	V
$I_{DSS}$	Drain-to-Source Leakage Current	$V_{DS} = 40\text{V}$ , $T_J = 25^\circ\text{C}$	-	-	1	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $T_J = 175^\circ\text{C}$ (Note 4)	-	-	1	mA
$I_{GSS}$	Gate-to-Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA

**On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\mu\text{A}$	2.0	3.0	4.0	V
$R_{DS(on)}$	Drain to Source On Resistance	$I_D = 20\text{A}$ , $T_J = 25^\circ\text{C}$	-	5.0	5.8	$\text{m}\Omega$
		$V_{GS} = 10\text{V}$ , $T_J = 175^\circ\text{C}$ (Note 4)	-	8.5	10.0	$\text{m}\Omega$

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 20\text{V}$ , $V_{GS} = 0\text{V}$ , $f = 1\text{MHz}$	-	2100	-	pF
$C_{oss}$	Output Capacitance		-	710	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	44	-	pF
$R_g$	Gate Resistance	$f = 1\text{MHz}$	-	1.8	-	$\Omega$
$Q_{g(ToT)}$	Total Gate Charge	$V_{GS} = 0$ to $10\text{V}$	-	29	43	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to $2\text{V}$				
$Q_{gs}$	Gate-to-Source Gate Charge	$V_{DD} = 20\text{V}$ $I_D = 20\text{A}$	-	9.5	-	nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge		-	5.4	-	nC

**Switching Characteristics**

$t_{on}$	Turn-On Time	$V_{DD} = 20\text{V}$ , $I_D = 20\text{A}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 6\Omega$	-	-	29	ns
$t_{d(on)}$	Turn-On Delay		-	14	-	ns
$t_r$	Rise Time		-	8	-	ns
$t_{d(off)}$	Turn-Off Delay		-	21	-	ns
$t_f$	Fall Time		-	6	-	ns
$t_{off}$	Turn-Off Time		-	-	35	ns

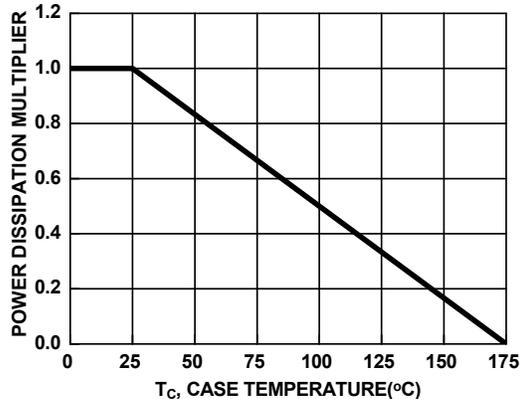
**Drain-Source Diode Characteristics**

$V_{SD}$	Source-to-Drain Diode Voltage	$I_{SD} = 20\text{A}$ , $V_{GS} = 0\text{V}$	-	-	1.25	V
		$I_{SD} = 10\text{A}$ , $V_{GS} = 0\text{V}$	-	-	1.2	V
$t_{rr}$	Reverse-Recovery Time	$I_F = 20\text{A}$ , $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	48	63	ns
$Q_{rr}$	Reverse-Recovery Charge	$V_{DD} = 32\text{V}$	-	40	52	nC

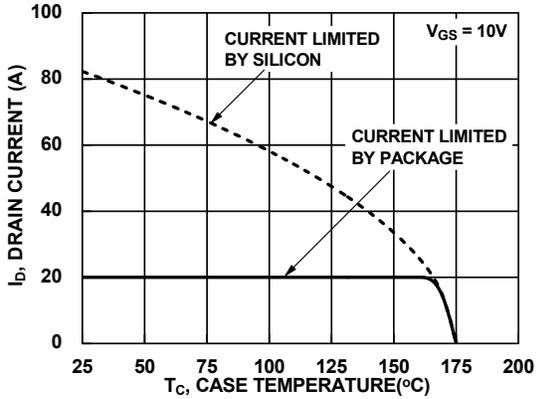
**Note:**

4: The maximum value is specified by design at  $T_J = 175^\circ\text{C}$ . Product is not tested to this condition in production.

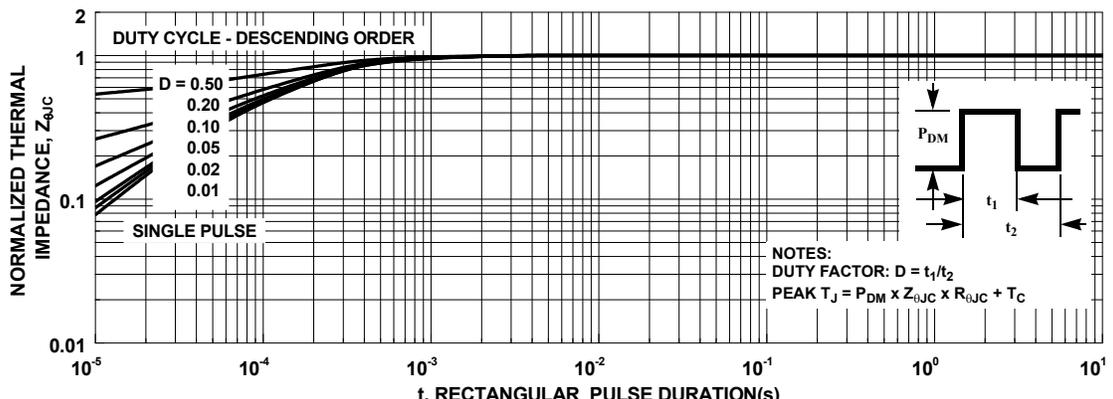
**Typical Characteristics**



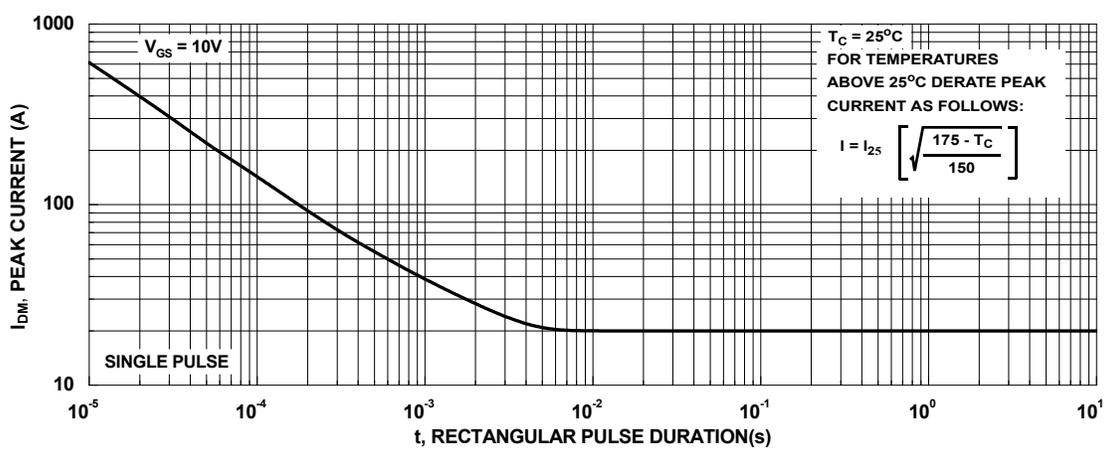
**Figure 1. Normalized Power Dissipation vs. Case Temperature**



**Figure 2. Maximum Continuous Drain Current vs. Case Temperature**



**Figure 3. Normalized Maximum Transient Thermal Impedance**



**Figure 4. Peak Current Capability**

## Typical Characteristics

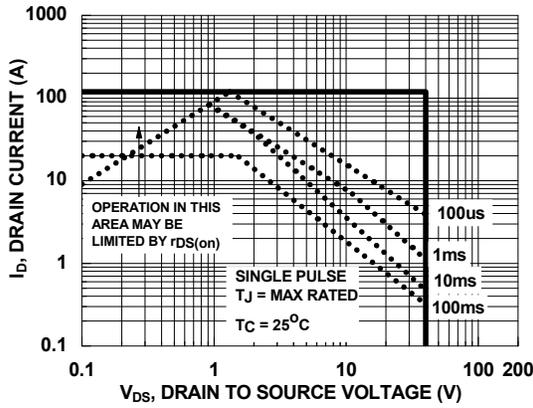
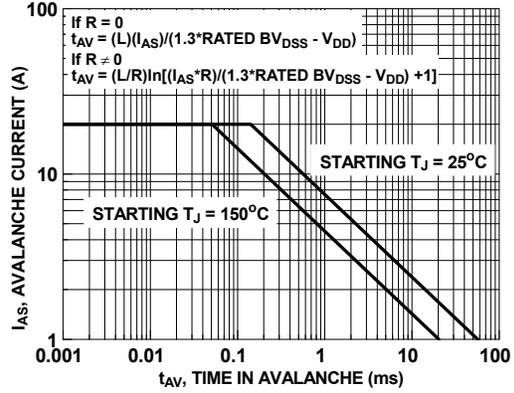


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

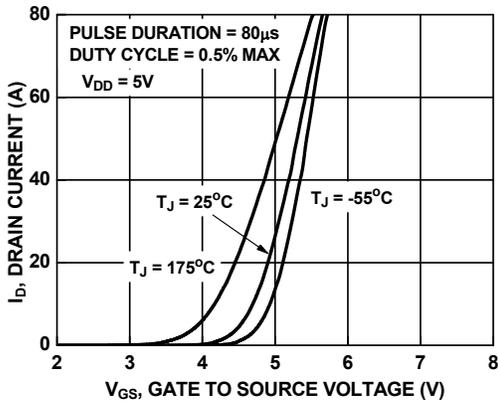


Figure 7. Transfer Characteristics

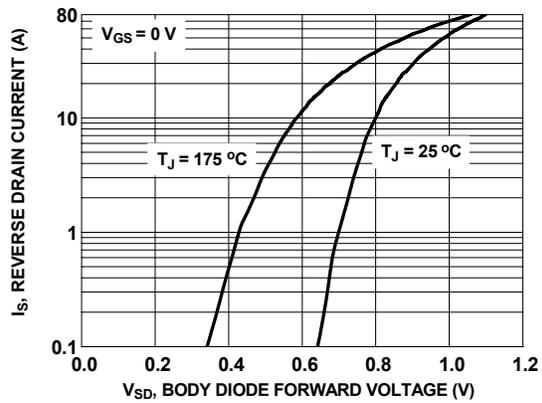


Figure 8. Forward Diode Characteristics

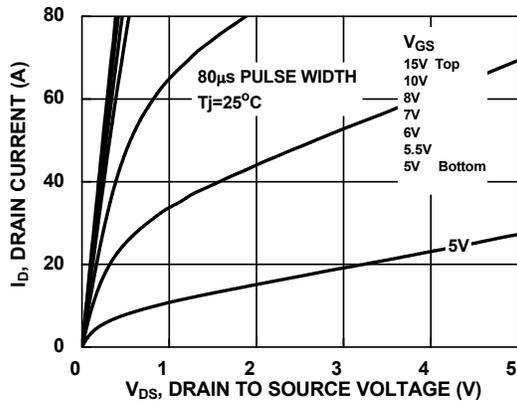


Figure 9. Saturation Characteristics

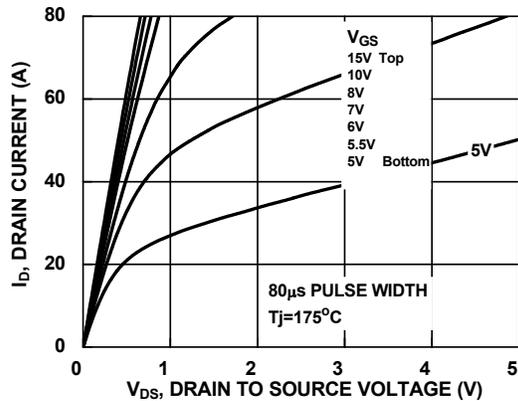


Figure 10. Saturation Characteristics

## Typical Characteristics

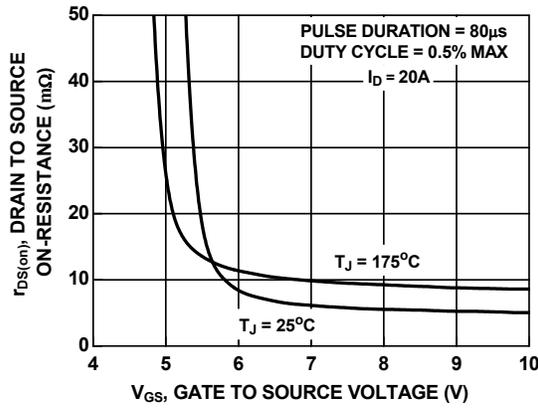


Figure 11.  $R_{DS(on)}$  vs. Gate Voltage

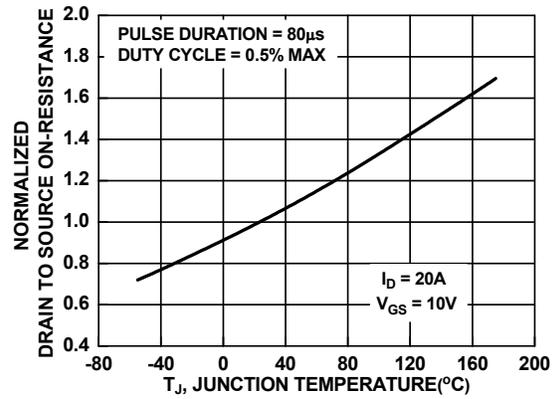


Figure 12. Normalized  $R_{DS(on)}$  vs. Junction Temperature

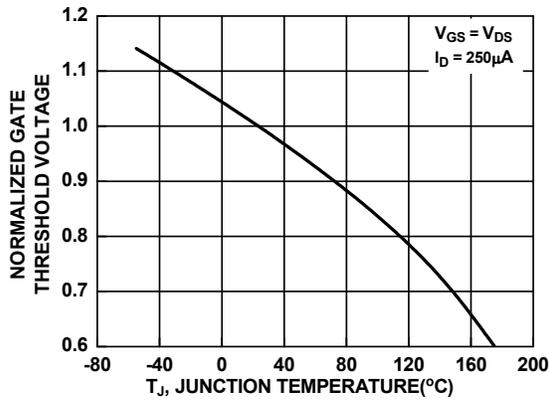


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

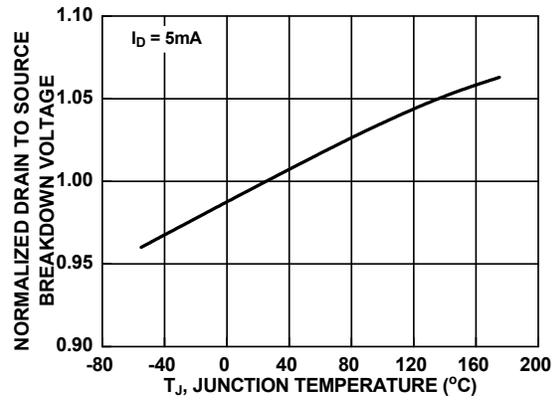


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

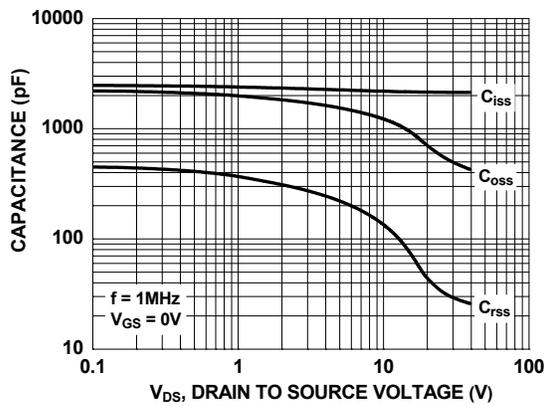


Figure 15. Capacitance vs. Drain to Source Voltage

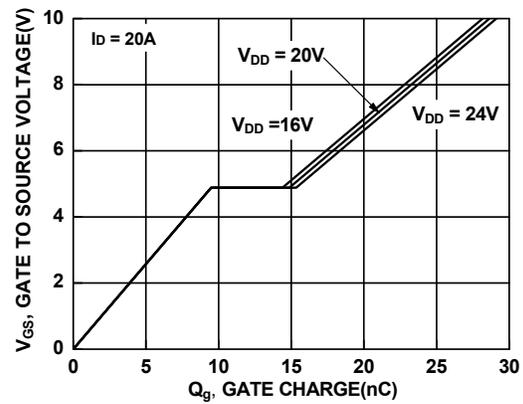
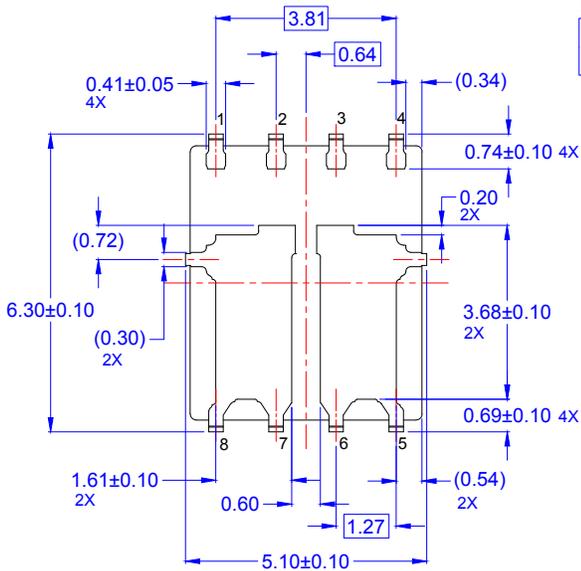
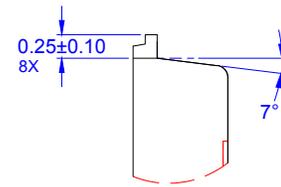
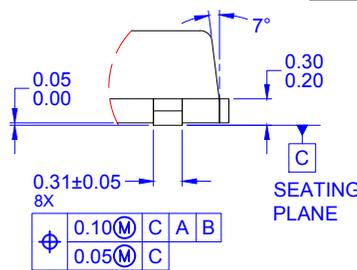
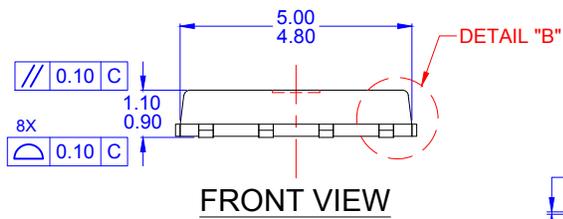
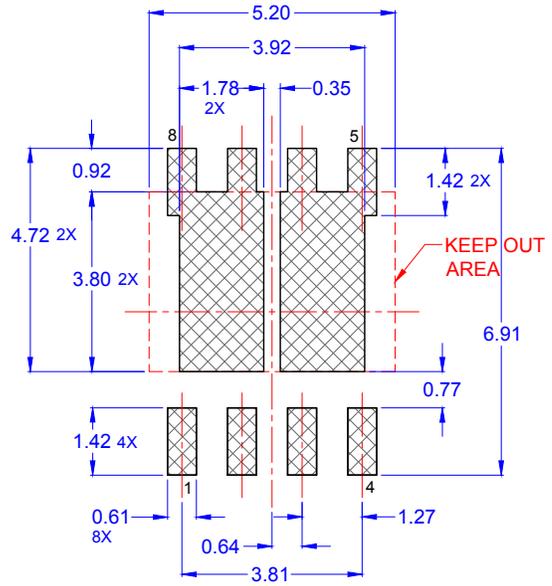
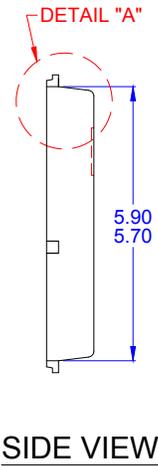
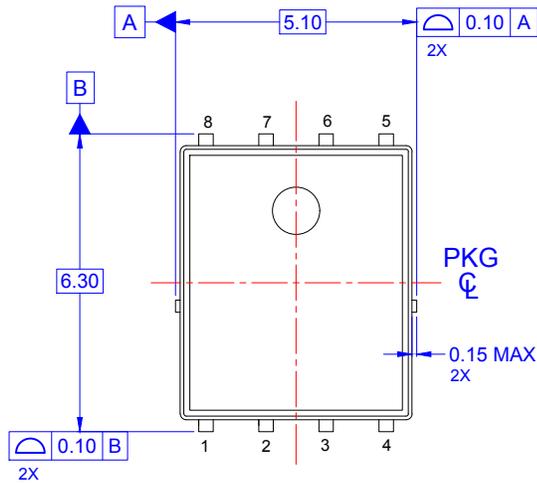


Figure 16. Gate Charge vs. Gate to Source Voltage



DETAIL "B"

DETAIL "A"

- NOTES: UNLESS OTHERWISE SPECIFIED
- A) PACKAGE STANDARD REFERENCE: JEDEC REGISTRATION, MO-240, ISSUE B, VAR AA, DATED 10/2009.
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
  - D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
  - E) DRAWING FILE NAME: MKT-PQFN08UREV1

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